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OMB No. 0651-0027 (exp. 6/30/2008)	20 - 2005  U.S. DEPARTMENT OF COMMERCE U.S. Patent and Trademark Office  Attorney Docket No. 520.45520X00
To the Director of the U.S. Patent and Trademark Office: Fig.	ments or the new address(es) below.
Name of conveying party(ies):     Kenichi TANAKA Hidetoshi MATSUMOTO     Isao OHBU Kazuhiro MOCHIZUKI     Tomonori TANOUE Chisaki TAKUBO     Hiroyuki UCHIYAMA	2. Name and address of receiving party(ies) Name: RENESAS TECHNOLOGY CORP.
Additional name(s) of conveying party(ies) attached?   3. Nature of conveyance/Execution Date(s):  Execution Date(s) _September 14, 2005, September 28, 2005, September 22, 2005, September 15, 2005, October 4, 2005, September 16, 2005, September 14, 2005  Assignment	Street Address: 4-1, Marunouchi 2-chome Chiyoda-ku, Tokyo, Japan
Other	Additional name(s) & address(es) attached? ☐ Yes ☒ No
Application or patent numbers(s):  A. Patent Application No.(s)	This document is being filed together with a new application.  B. Patent Registration No.(s)
Additional number(s) attached ☐ Yes ☒ No	
Name and address of party to whom correspondence concerning document should be mailed:	6. Total number of applications and patents involved
Name: <b>ANTONELLI, TERRY, STOUT &amp; KRAUS, LLP</b> Internal Address: 1300 NORTH 17 <sup>TH</sup> STREET – SUITE 1800	7. Total fee (37 CFR 3.41)
City: <b>ARLINGTON</b> State: <b>VA</b> Zip <b>22209</b> Phone Number: 703-312-6000  Fax Number: 703-312-6666  Email Address: email@antonelli.com	8. Payment Information  a. Credit Card Last 4 Numbers1065 Expiration Date06/06  b. Deposit account number: 01-2135  Authorized User Name Alan E. Schiavelli

Signature

Gregory E. Montone, Reg#28,141

Name of Person Signing

Total number of pages including cover sheet, attachments, and document: 2

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**PATENT** 

**REEL: 017093 FRAME: 0716** 

10/12/2005

Date

## ASSIGNMENT ( 譲 渡 証 )

As a below named inventor, I hereby declare that:

IN CONSIDERATION of the sum of One Dollar (\$1.00) or the equivalent thereof, and other good and valuable consideration paid to me citizen of Japan by Renesas Technology Corp.

a corporation organized under the laws of Japan,

located at 4-1, Marunouchi 2-chome, Chiyoda-ku, Tokyo, Japan

receipt of which is hereby acknowledged I do hereby sell and assign to said Renesas Technology Corp. its successors and assigns, all my right, title and interest, in and for the United States of America, in and to

SEMICONDUCTOR DEVICE AND A MANUFACTURING METHOD THEREOF, AND SEMICONDUCTOR MODULE

invented by me (if only one is named below) or us (if plural inventors are named below) and described in the application for United States Letters Patent therefor, executed on even date herewith, and all United States Letters Patent which may be granted therefor, and all divisions, continuations and extensions thereof, the said interest being the entire ownership of the said Letters Patent when granted,

to be held and enjoyed by said Renesas Technology Corp.

its successors, assigns or other legal representatives, to the full end of term for which said Letters Patent may be granted as fully and entirely as the same would have been held and enjoyed by me or us if this assignment and sale had not been made;

And I hereby agree to sign and execute any further documents or instruments which may be necessary, lawful, and proper in the prosecution of the above-named application or in the preparation and prosecution of any continuing, continuation-in-part, substitute, divisional, renewal, reviewed or reissue applications or in any amendment, extension, or interference proceedings, or otherwise to secure the title thereto in said assignee;

And I do hereby authorize and request the Commissioner of Patents to issue said Letters Patent to said Renesas Technology Corp.

Signed on the date(s) indicated aside our signatures:

**RECORDED: 10/12/2005** 

INVENTOR(S)

(署名日)
9/14/2005
9/24/2005
9/22/2005
9/15/2005
10/4/2005
9/16/2005
9114/2005

PATENT REEL: 017093 FRAME: 0717

Date Signed